

# SN1A-S thru SN1M-S

1.0 Amp. Surface Mount Glass Passivated Rectifiers Voltage Range 50 to 1000 Volts Forward Current 1.0 Ampere

#### **Features**

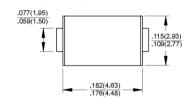
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Low profile package
- ◆ Built-in strain relief, ideal for automated placement
- ◆ Easy pick and place
- High temperature soldering:
  260°C/10 seconds at terminals

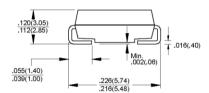
#### **Mechanical Data**

- ◆ Case: New SMA molded plastic
- ◆ Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- ◆ Weight: 0.004 ounce, 0.115 gram



## DO-214AC (SMAJ)





Dimensions in inches and (millimeters)

# **Maximum Ratings and Electrical Characteristics**

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

Parameter	Symbols	SN1A-S	SN1B-S	SN1D-S	SN1G-S	SN1J-S	SN1K-S	SN1M-S	Units
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	Volts
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	Volts
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	Volts
Maximum average forward rectified current See Fig.1	I <sub>(AV)</sub>	1.0							Amp
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	L	30.0							Amps
Maximum instantaneous forward voltage @ 1.0A	V <sub>F</sub>	1.1							Volts
	I <sub>R</sub>	5.0 100							uA uA
Maximum reverse recovery time (Note 1)	t,,	2.0							uS
Typical junction capacitance (Note 2)	C <sub>J</sub>	15							pF
Operating temperature range	T <sub>J</sub>	-55 to +125							°C
Storage temperature range	T <sub>STG</sub>	-55 to +150							°C

Notes: 1. Reverse Recovery Test Conditions: I<sub>E</sub>=0.5A, I<sub>R</sub>=1.0A, I<sub>RR</sub>=0.25A

2. Measured at 1 MHz and Applied  $\rm V_{\rm R}\!=\!4.0~Volts$ 

## RATINGS AND CHARACTERISTIC CURVES

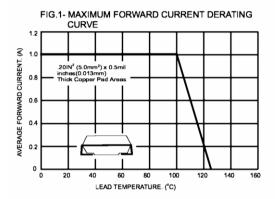


FIG.3-TYPICAL FORWARD CHARACTERISTICS

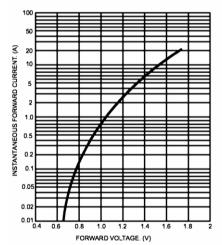


Figure : New SMA Assembly

Process

FIG.2- MAXIMUM NON-REPETITIVE FORWARD

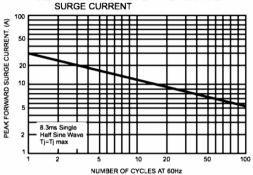


FIG.4- TYPICAL REVERSE CHARACTERISTICS

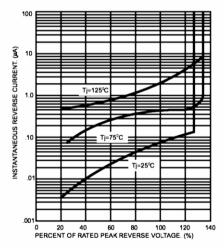


FIG.5- TYPICAL JUNCTION CAPACITANCE

